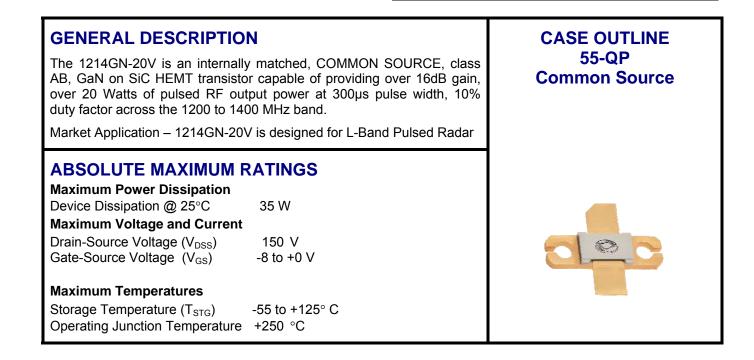


20 Watts - 50 Volts, 300 μs, 10% L-Band Radar 1200 - 1400 MHz



ELECTRICAL CHARACTERISTICS @ 25°C

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Units
Pout	Output Power	Pin=.5W Freq=1200,1300,1400 MHz	20	25		W
Gp	Power Gain	Pin=.5W Freq=1200,1300,1400 MHz	16	17		dB
ηd	Drain Efficiency	Pin=.5W Freq=1200,1300,1400 MHz	45	50		%
Dr	Droop	Pin=.5W Freq=1200,1300,1400 MHz			.5	dB
VSWR-T	Load Mismatch Tolerance	Pout=20W, Freq= 1300MHz			5:1	
Өјс	Thermal Resistance	Pulse Width=300uS, Duty=10%			0.1	°C/W

• Bias Condition: Vdd=+50V, Idq=20mA constant current (Vgs= -2.0 ~ -4.5V typical)

FUNCTIONAL CHARACTERISTICS @ 25°C

I _{D(Off)}	Drain leakage current	$V_{gS} = -8V, V_D = 60V$		10	mA
I _{G(Off)}	Gate leakage current	$V_{gS} = -8V, V_D = 0V$		8	mA
BV _{DSS}	Drain-source breakdown voltage	V _{gs} =-8V, I _D = 10mA	250		V

Export Classification: EAR-99

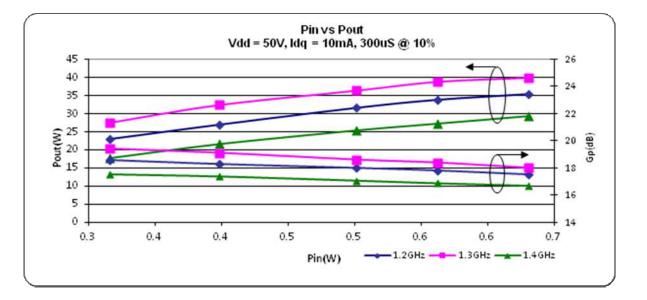
April 2013

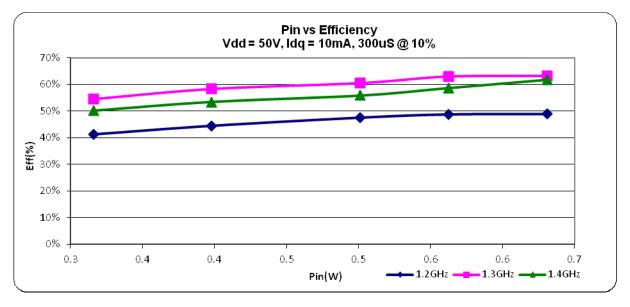


20 Watts - 50 Volts, 300 µs, 10% L-Band Radar 1200 - 1400 MHz

TYPICAL BROAD BAND PERFORMACE DATA

Frequency	Pin (W)	Pout (W)	ld (A)	RL (dB)	Nd (%)	G (dB)	Droop (dB)
1200 MHz	.5	31.6	.14	-9	48	18	0.25
1300 MHz	.5	36.3	.129	-10	61	18.6	0.20
1400 MHz	.5	25.4	.1	-8	56	17.05	0.15

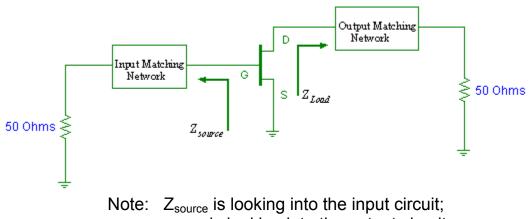






20 Watts - 50 Volts, 300 µs, 10% L-Band Radar 1200 - 1400MHz

TRANSISTOR IMPEDANCE INFORMATION



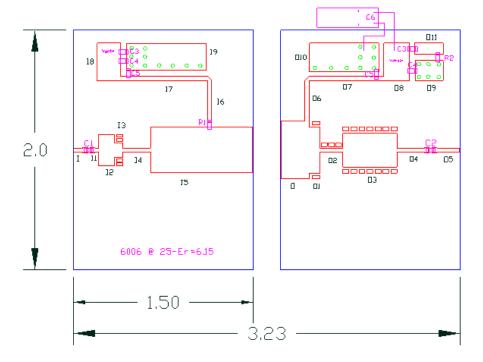
 Z_{Load} is looking into the output circuit.

Impedance Data						
Freq (GHz)	ZI					
1.2	3.6 – j1.1	8.5 – j2.95				
1.3	4.0 – j.50	12.1 – j5.68				
1.4	4.4 – j.14	19.7 – j7.34				



20 Watts - 50 Volts, 300 µs, 10% L-Band Radar 1200 - 1400 MHz

TEST CIRCUIT DIAGRAM



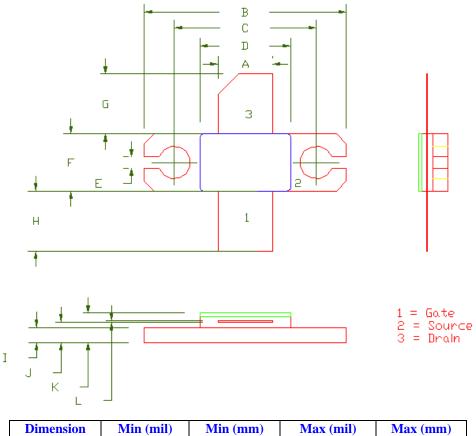
Board Material: Roger Duriod 6006 @ 25 Mil Thickness, Er=6.15

	Component List			Input Matching Network				Output Matching Network		
ltem	Description		Value	ltem	W (Mil)	L (Mil)		ltem	W (Mil)	L (Mil)
C1	Chip Cap A size	ATC800A1010JT250XT	100pF		35	116		0	480	200
C2	Chip Cap A size	ATC800A680JT250XT	68pF	11	35	70		01	384	90
C3	Chip Cap B size	ATC200B103KW50XT	10,000pF	12	262	134	Т	02	35	190
C4	Chip Cap B size	ATC100B102102KW50XT	1000pF	13	124	65		03	280	450
C5	Chip Cap B size	ATC100B101FW1000XT	100pF	4	35	235	Т	04	35	270
C6	Electrolytic Cap (63V)	ANY	1000uF	15	380	850	Т	05	35	230
R1	Chip Resistor size 0805	ANY	20.5 ohms	16	35	350		06	35	340
R2	Chip Resistor size 0805	ANY	2 ohm	17	35	730		07	35	620
Note:				18	310	194	Т	08	310	210
	Need 2x of C3,C4,C5			19	220	660		09	170	230
	Board Material: Roger D	uroid 6006 @ 25 mils thick	, Er=6.15					O10	240	578
								011	90	230



20 Watts - 50 Volts, 300 µs, 10% L-Band Radar 1200 - 1400 MHz

55-QP PACKAGE DIMENSION



Dimension	Min (mil)	Min (mm)	Max (mil)	Max (mm)
Α	213	5.41	217	5.51
В	798	20.26	802	20.37
С	560	14.22	564	14.32
D	258	6.55	362	9.19
E	43	1.09	47	1.19
F	226	5.74	230	5.84
G	235	5.96	239	6.07
Н	235	5.96	239	6.07
Ι	60	1.52	62	1.57
J	81	2.06	82	2.08
K	116	2.94	118	2.99
L	4	.102	6	.152



20 Watts - 50 Volts, 300 µs, 10% L-Band Radar 1200 - 1400 MHz

The information contained in the document is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other missioncritical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. The product is subject to other terms and conditions which can be located on the Web at http://www.microsemi.com/legal/tnc.asp.

Revision History

Revision Level / Date Para. Affected		Description			
0.1 / 6 March 2013 -		Initial Preliminary Release			